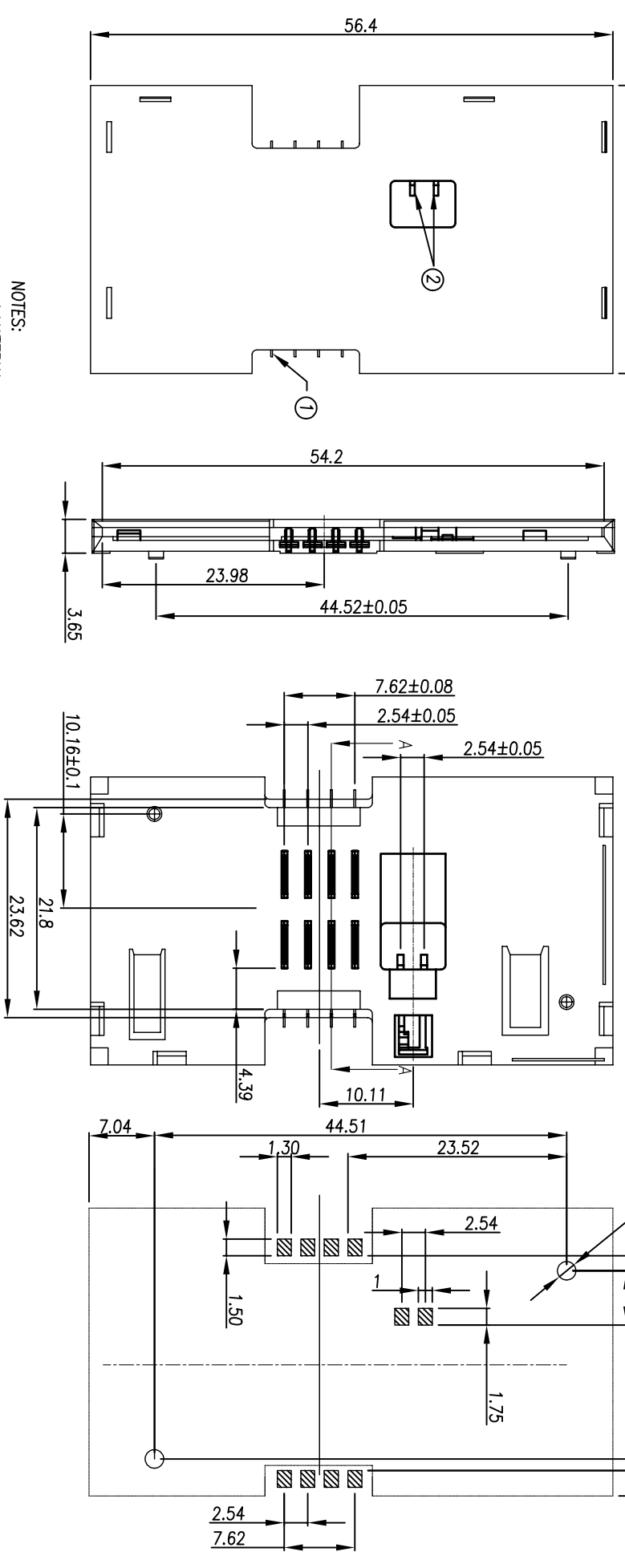
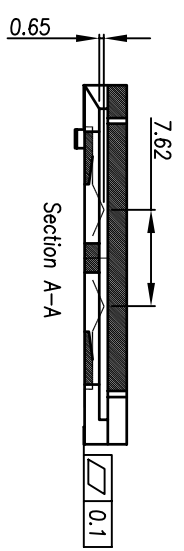


REV	MODIFICATION	DATE	DRAW
B	EN-06-0344	95/03/28	TERENCE
C	EN-06-1002	95/10/03	TERENCE
D	EN-07-0324	96/03/29	TERENCE



Reference dimension for PCB layout

NOTES:

1. MATERIAL:
BASE: NYLON 9T BLACK: 30% GLASS FIBER: UL 94V-0
COVER: NYLON 9T BLACK: 30% GLASS FIBER: UL 94V-0
① TERMINAL 1: PHOSPHOR BRONZE C5210R-H T=0.2±0.01mm
② TERMINAL 2: PHOSPHOR BRONZE C5210R-H T=0.2±0.01mm
2. FINISH:
① 05 MICRONCH GOLD PLATED IN CONTACT AREA.
② 05 MICRONCH GOLD PLATED IN CONTACT AREA.
③ 100 MICRONCH ~150 MICRONCH TIN ON SOLDER TAILS.
④ 50 MICRONCH NICKEL UNDERPLATED ALL OVER.
3. BURR IS 0.05 MAX.
4. THE RADIUS ARE 0.15 MAX UNLESS SPECIFIED

DIMENSION IN mm [inch]		PROD. SPEC.	PKG. SPEC.	APPROVE	CHECK	DRAW
TOLERANCE UNLESS OTHERWISE SPECIFIED						
X±0.25	X.± 3"					
.XX±0.25	.X"±					
.XXX±0.20	.XX"±					

FILE NO.	DWG NO.	SMCMB-20805B102S
TITLE	SIM CARD ACCEPTOR	
TITLE	SMT TYPE SLIDING	
TITLE	CUSTOMER DRAWING	

SIZE	A4
SCALE	1.5:1
PROJ.	SHEET 1
REV	D

